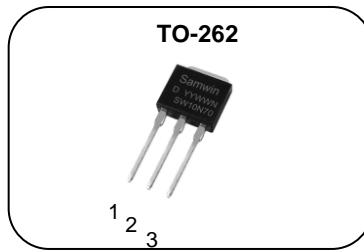
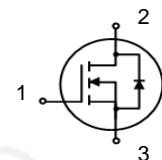


**N-channel Enhanced mode TO-262 MOSFET****Features**

- High ruggedness
- Low  $R_{DS(ON)}$  (Typ 1.0Ω)@ $V_{GS}=10V$
- Low Gate Charge (Typ 37nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application: LED, Charge, TV-Power

**1. Gate 2. Drain 3. Source** **$BV_{DSS}$  : 700V** **$I_D$  : 10A** **$R_{DS(ON)}$  : 1.0Ω****General Description**

This power MOSFET is produced with advanced technology of SAMWIN.

This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.

**Order Codes**

Item	Sales Type	Marking	Package	Packaging
1	SW U 10N70D	SW10N70D	TO-262	TUBE

**Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain to source voltage	700	V
$I_D$	Continuous drain current (@ $T_C=25^\circ C$ )	10*	A
	Continuous drain current (@ $T_C=100^\circ C$ )	6*	A
$I_{DM}$	Drain current pulsed (note 1)	40	A
$V_{GS}$	Gate to source voltage	$\pm 30$	V
$E_{AS}$	Single pulsed avalanche energy (note 2)	298	mJ
$E_{AR}$	Repetitive avalanche energy (note 1)	35	mJ
$dv/dt$	Peak diode recovery $dv/dt$ (note 3)	5	V/ns
$P_D$	Total power dissipation (@ $T_C=25^\circ C$ )	208	W
	Derating factor above 25°C	1.7	W/ $^\circ C$
$T_{STG}, T_J$	Operating junction temperature & storage temperature	-55 ~ + 150	$^\circ C$
$T_L$	Maximum lead temperature for soldering purpose, 1/8 from case for 5 seconds.	300	$^\circ C$

\*. Drain current is limited by junction temperature.

**Thermal characteristics**

Symbol	Parameter	Value	Unit
$R_{thjc}$	Thermal resistance, Junction to case	0.6	$^\circ C/W$
$R_{thja}$	Thermal resistance, Junction to ambient	65	$^\circ C/W$

Electrical characteristic ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain to source breakdown voltage	$V_{\text{GS}}=0\text{V}, I_D=250\mu\text{A}$	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu\text{A}$ , referenced to $25^\circ\text{C}$		0.62		$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Drain to source leakage current	$V_{\text{DS}}=700\text{V}, V_{\text{GS}}=0\text{V}$			1	$\mu\text{A}$
		$V_{\text{DS}}=560\text{V}, T_C=125^\circ\text{C}$			50	$\mu\text{A}$
$I_{\text{GSS}}$	Gate to source leakage current, forward	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$			100	nA
	Gate to source leakage current, reverse	$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$			-100	nA
<b>On characteristics</b>						
$V_{\text{GS}(\text{TH})}$	Gate threshold voltage	$V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$	2.5		4.5	V
$R_{\text{DS}(\text{ON})}$	Drain to source on state resistance	$V_{\text{GS}}=10\text{V}, I_D=5\text{A}$		1.0	1.4	$\Omega$
$G_{\text{fs}}$	Forward transconductance	$V_{\text{DS}}=30\text{V}, I_D=5\text{A}$		8.5		S
<b>Dynamic characteristics</b>						
$C_{\text{iss}}$	Input capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=25\text{V}, f=1\text{MHz}$		1410		pF
$C_{\text{oss}}$	Output capacitance			116		
$C_{\text{rss}}$	Reverse transfer capacitance			18		
$t_{\text{d}(\text{on})}$	Turn on delay time	$V_{\text{DS}}=350\text{V}, I_D=10\text{A}, R_G=25\Omega, V_{\text{GS}}=10\text{V}$ (note 4,5)		24		ns
$t_r$	Rising time			45		
$t_{\text{d}(\text{off})}$	Turn off delay time			98		
$t_f$	Fall time			44		
$Q_g$	Total gate charge			37		nC
$Q_{\text{gs}}$	Gate-source charge	$V_{\text{DS}}=560\text{V}, V_{\text{GS}}=10\text{V}, I_D=10\text{A}$ (note 4,5)		8		
$Q_{\text{gd}}$	Gate-drain charge			17		
$R_g$	Gate resistance	$V_{\text{DS}}=0\text{V}$ , Scan F mode		1.7		$\Omega$

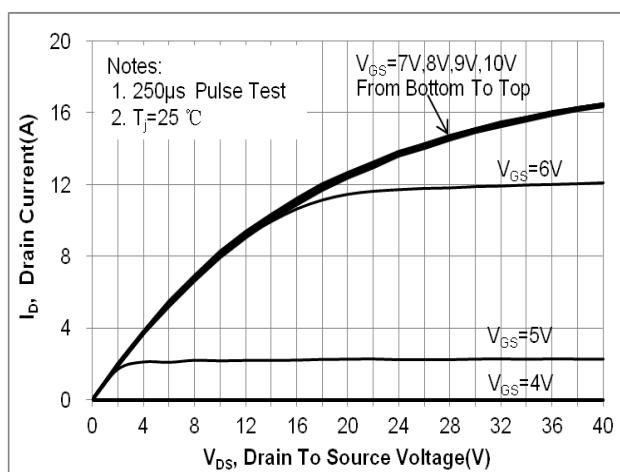
## Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			10	A
$I_{\text{SM}}$	Pulsed source current				40	A
$V_{\text{SD}}$	Diode forward voltage drop.	$I_s=10\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
$t_{\text{rr}}$	Reverse recovery time	$I_s=10\text{A}, V_{\text{GS}}=0\text{V}, dI_F/dt=100\text{A/us}$		526		ns
$Q_{\text{rr}}$	Reverse recovery charge			5.3		$\mu\text{C}$

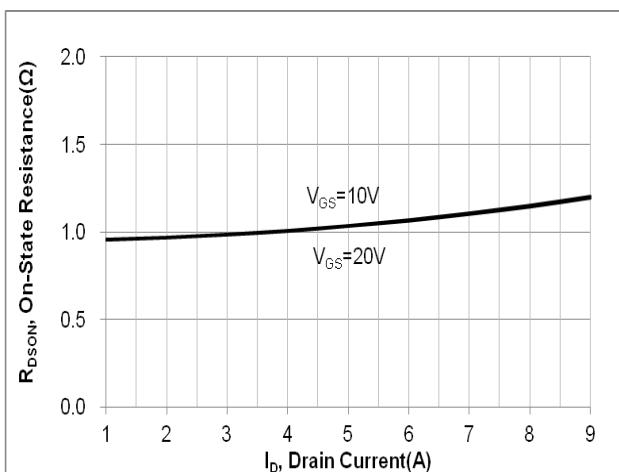
※. Notes

1. Repetitive rating : pulse width limited by junction temperature.
2.  $L=6\text{mH}, I_{\text{AS}}=10\text{A}, V_{\text{DD}}=50\text{V}, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3.  $I_{\text{SD}} \leq 10\text{A}, dI/dt = 100\text{A/us}, V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$ , Starting  $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
5. Essentially independent of operating temperature.

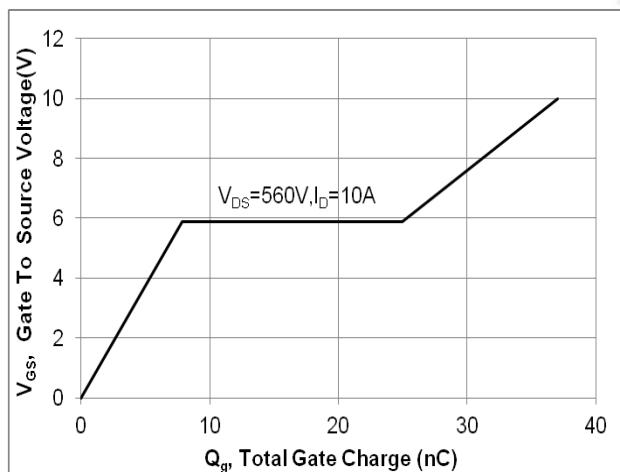
**Fig. 1. On-state characteristics**



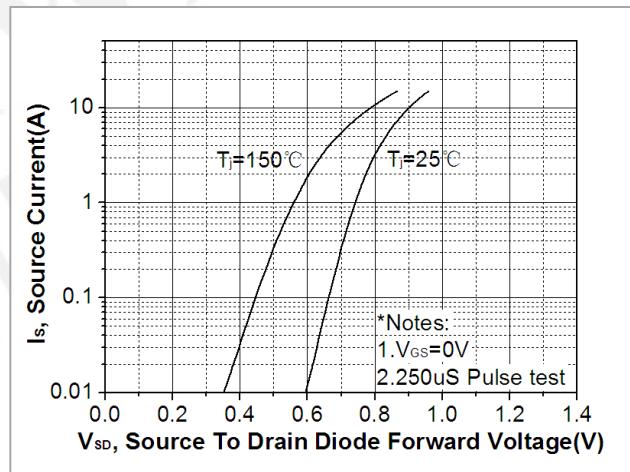
**Fig. 2. On-resistance variation vs. drain current and gate voltage**



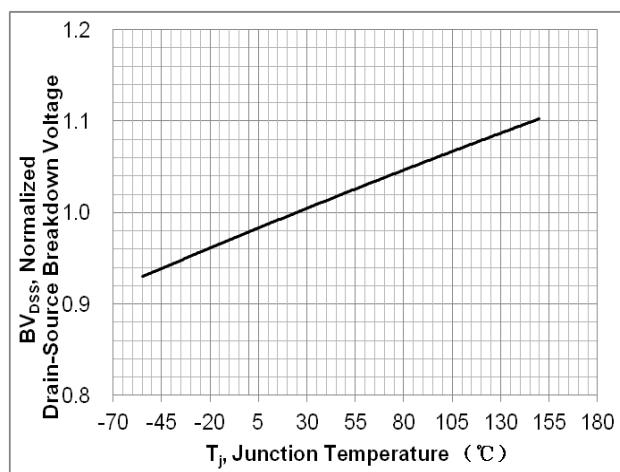
**Fig. 3. Gate charge characteristics**



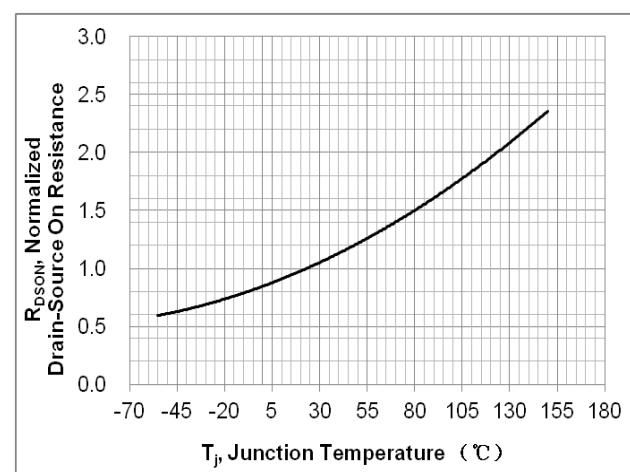
**Fig. 4. On-state current vs. diode forward voltage**



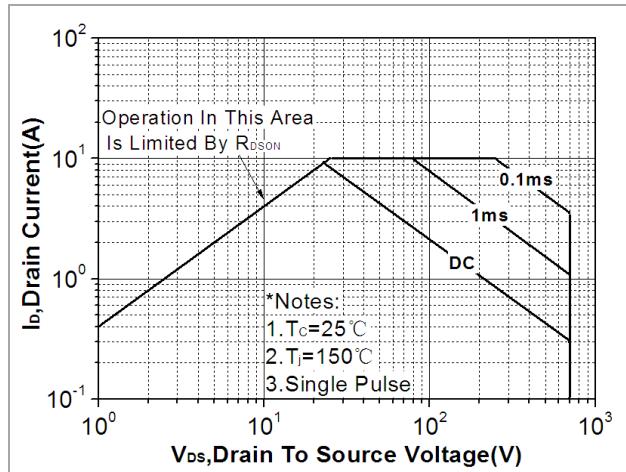
**Fig. 5. Breakdown voltage variation vs. junction temperature**



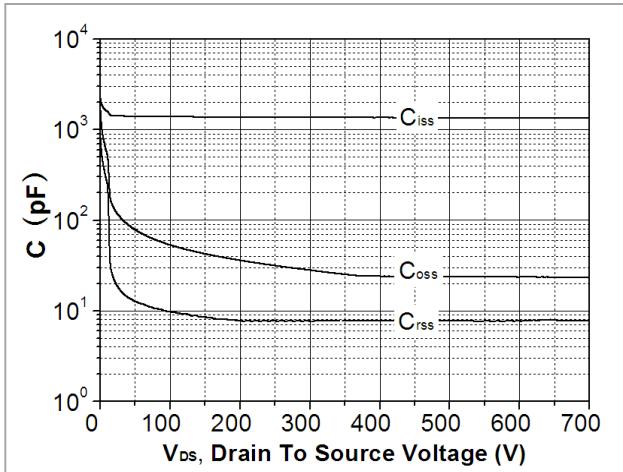
**Fig. 6. On-resistance variation vs. junction temperature**



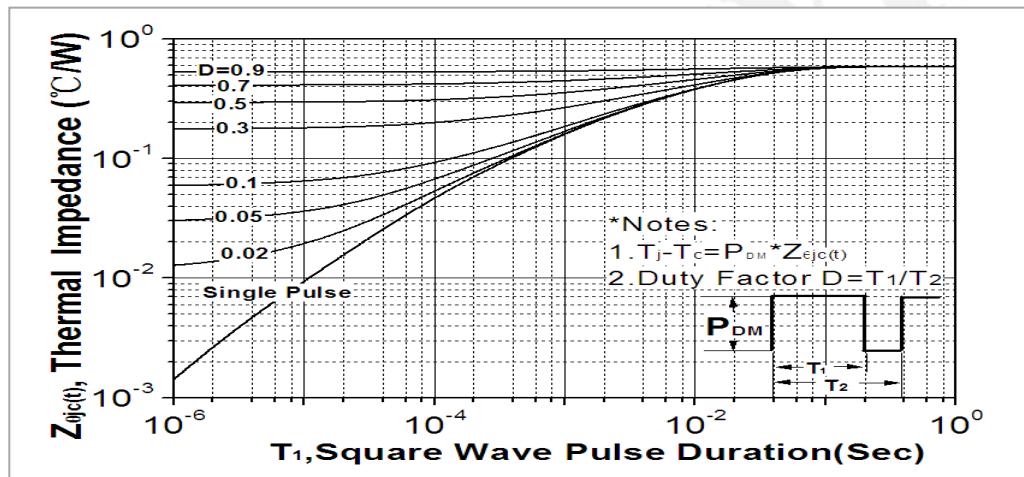
**Fig. 7. Maximum safe operating area**



**Fig. 8. Capacitance Characteristics**



**Fig. 9. Transient thermal response curve**



**Fig. 10. Gate charge test circuit & waveform**

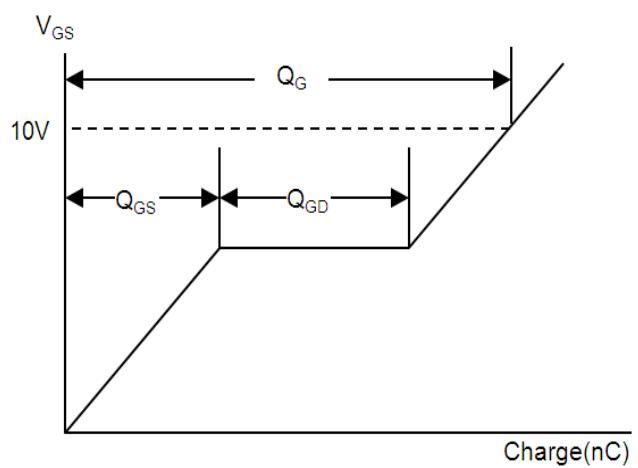
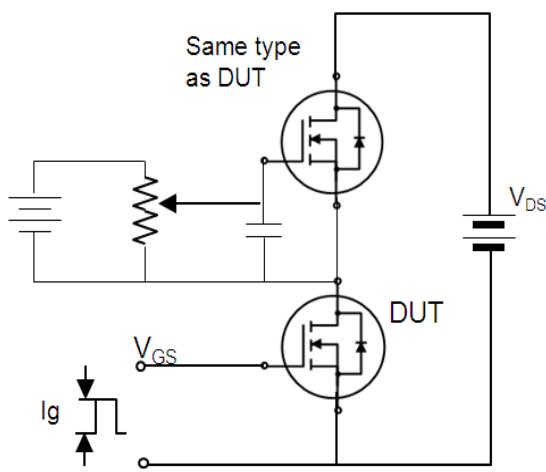


Fig. 11. Switching time test circuit & waveform

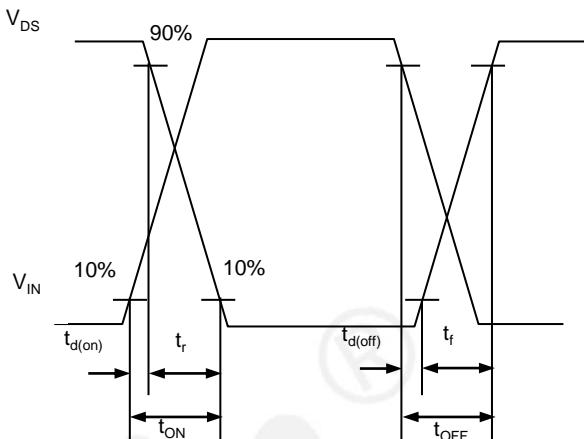
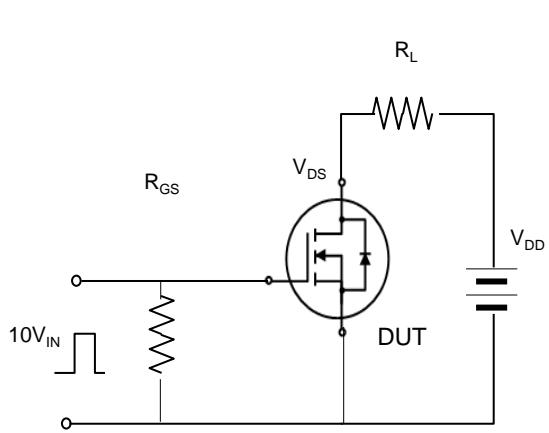


Fig. 12. Unclamped Inductive switching test circuit & waveform

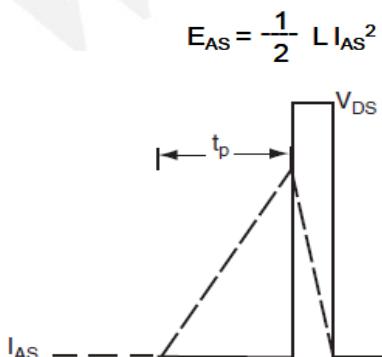
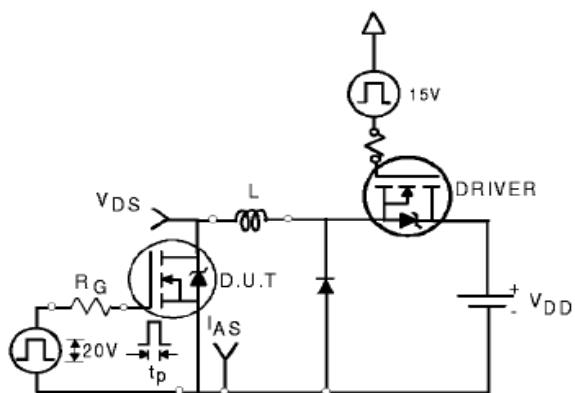
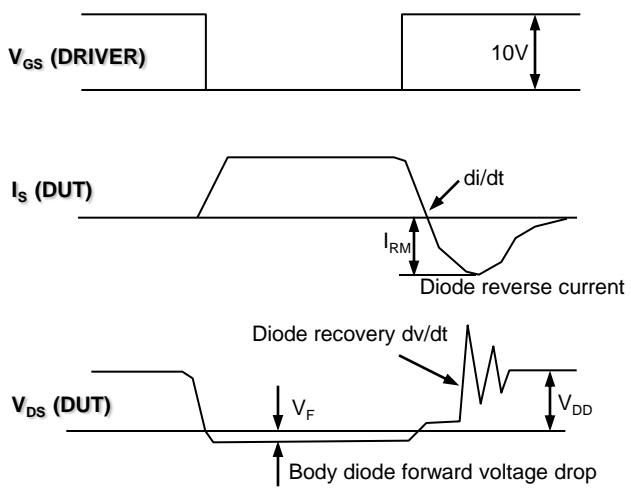
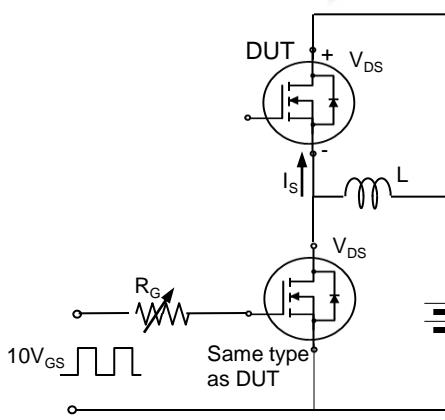


Fig. 13. Peak diode recovery dv/dt test circuit & waveform



\*. dv/dt controlled by RG

\*. Is controlled by pulse period

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- \* All the data & curve in this document was tested in XI'AN SEMIPOWER TESTING & APPLICATION CENTER.
- \* This product has passed the PCT,TC,HTRB,HTGB,HAST,PC and Solderdunk reliability testing.
- \* Qualification standards can also be found on the Web site (<http://www.semipower.com.cn>) 
- \* Suggestions for improvement are appreciated, Please send your suggestions to [samwin@samwinsemi.com](mailto:samwin@samwinsemi.com)